

DM5407,DM7407

DM5407 DM7407 Hex Buffers with High Voltage Open-Collector Outputs



Literature Number: SNOS226A

DM5407/DM7407 Hex Buffers with High Voltage Open-Collector Outputs

General Description

This device contains six independent gates each of which performs a buffer function. The open-collector outputs require external pull-up resistors for proper logical operation.

Pull-Up Resistor Equations

$$R_{MAX} = \frac{V_O (Min) - V_{OH}}{N_1 (I_{OH}) + N_2 (I_{IH})}$$

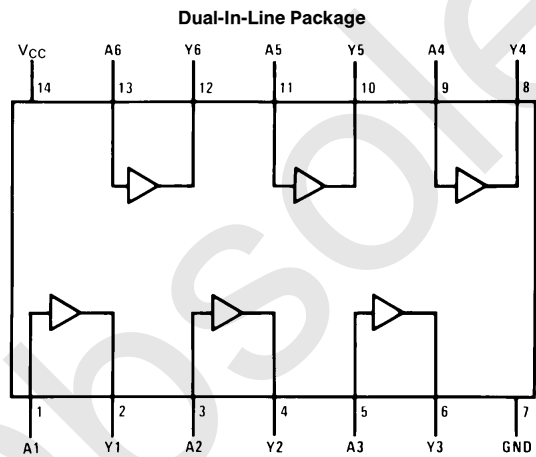
$$R_{MIN} = \frac{V_O (Max) - V_{OL}}{I_{OL} - N_3 (I_{IL})}$$

Where: $N_1 (I_{OH})$ = total maximum output high current for all outputs tied to pull-up resistor

$N_2 (I_{IH})$ = total maximum input high current for all inputs tied to pull-up resistor

$N_3 (I_{IL})$ = total maximum input low current for all inputs tied to pull-up resistor

Connection Diagram



TL/F/6497-1

Order Number DM5407J, DM5407W, DM7407M or DM7407N
See NS Package Number J14A, M14A, N14A or W14B

Function Table

$$Y = A$$

Input	Output
A	Y
L	L
H	H

H = High Logic Level

L = Low Logic Level

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	5.5V
Output Voltage	30V
Operating Free Air Temperature Range	
DM54	–55°C to +125°C
DM74	0°C to +70°C
Storage Temperature Range	–65°C to +150°C

Note: The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the “Electrical Characteristics” table are not guaranteed at the absolute maximum ratings. The “Recommended Operating Conditions” table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	DM5407			DM7407			Units
		Min	Nom	Max	Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.8			0.8	V
V _{OH}	High Level Output Voltage			30			30	V
I _{OL}	Low Level Output Current			30			40	mA
T _A	Free Air Operating Temperature	–55		125	0		70	°C

Electrical Characteristics over recommended operating free air temperature range (unless otherwise noted)

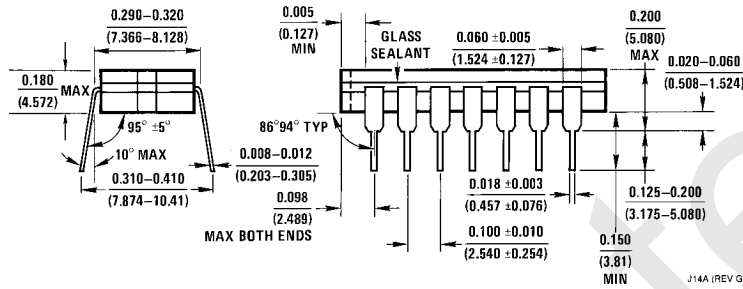
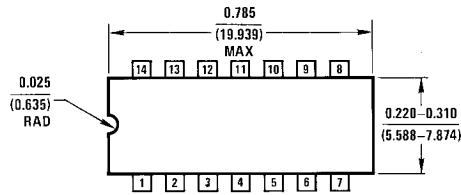
Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = –12 mA			–1.5	V
I _{CEX}	High Level Output Current	V _{CC} = Min, V _O = 30V V _{IH} = Min			250	μA
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = Max V _{IL} = Max			0.7	V
		I _{OL} = 16 mA, V _{CC} = Min			0.4	
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 5.5V			1	mA
I _{IH}	High Level Input Current	V _{CC} = Max, V _I = 2.4V			40	μA
I _{IL}	Low Level Input Current	V _{CC} = Max, V _I = 0.4V			–1.6	mA
I _{CCH}	Supply Current with Outputs High	V _{CC} = Max		29	41	mA
I _{CCL}	Supply Current with Outputs Low	V _{CC} = Max		21	30	mA

Switching Characteristics at V_{CC} = 5V and T_A = 25°C (See Section 1 for Test Waveforms and Output Load)

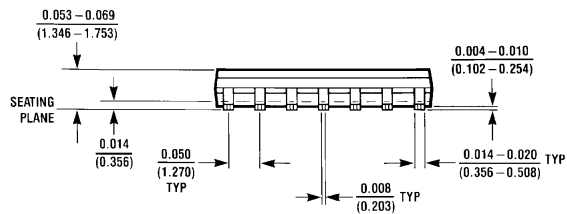
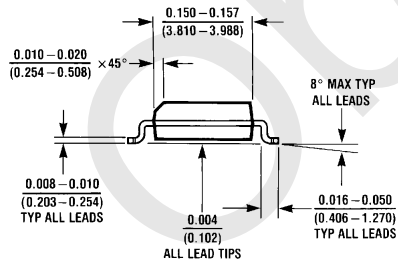
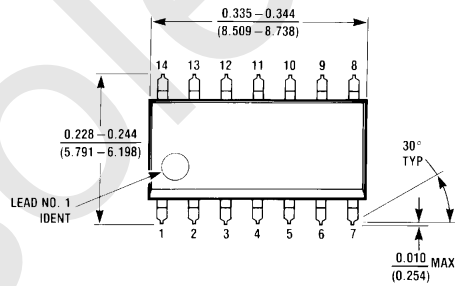
Symbol	Parameter	Conditions	Min	Max	Units
t _{PLH}	Propagation Delay Time Low to High Level Output	C _L = 15 pF R _L = 110Ω		10	ns
t _{PHL}	Propagation Delay Time High to Low Level Output			30	ns

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Physical Dimensions inches (millimeters)

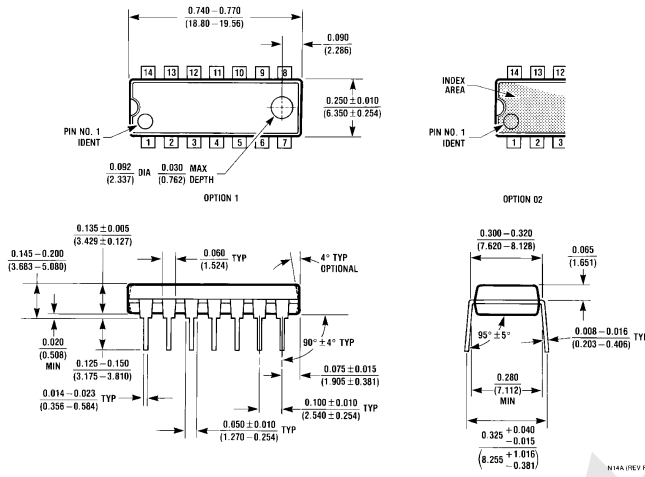


14-Lead Ceramic Dual-In-Line Package (J)
Order Number DM5407J
NS Package Number J14A

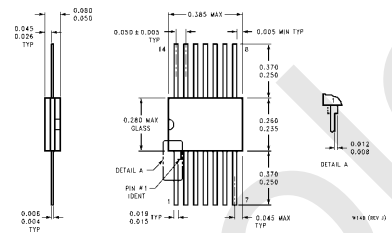


14-Lead Small Outline Molded Package (M)
Order Number DM7407M
NS Package Number M14A

Physical Dimensions inches (millimeters) (Continued)



14-Lead Molded Dual-In-Line Package (N)
Order Number DM7407N
NS Package Number N14A




14-Lead Ceramic Flat Package (W)
Order Number DM5407W
NS Package Number W14B

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